

# Bias Resistor Transistor

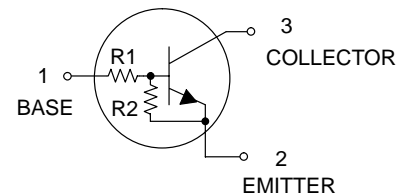
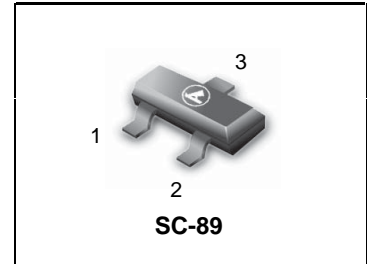
## NPN Silicon Surface Mount Transistor with Monolithic Bias Resistor Network

**LDTC123YET1G**

- **Applications**  
Inverter, Interface, Driver

- **Features**
  - 1) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
  - 2) The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.
  - 3) Only the on/off conditions need to be set for operation, making the device design easy.

- We declare that the material of product compliance with RoHS requirements.



● **Absolute maximum ratings** (Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply voltage	V <sub>CC</sub>	50	V
Input voltage	V <sub>IN</sub>	-5 to +12	V
Output current	I <sub>o</sub>	100	mA
	I <sub>C(Max.)</sub>	100	
Power dissipation	P <sub>d</sub>	200	mW
Junction temperature	T <sub>J</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

**DEVICE MARKING AND RESISTOR VALUES**

Device	Marking	R1 (K)	R2 (K)	Shipping
LDTC123YET1G	N8	2.2	10	3000/Tape & Reel
LDTC123YET3G	N8	2.2	10	10000/Tape & Reel

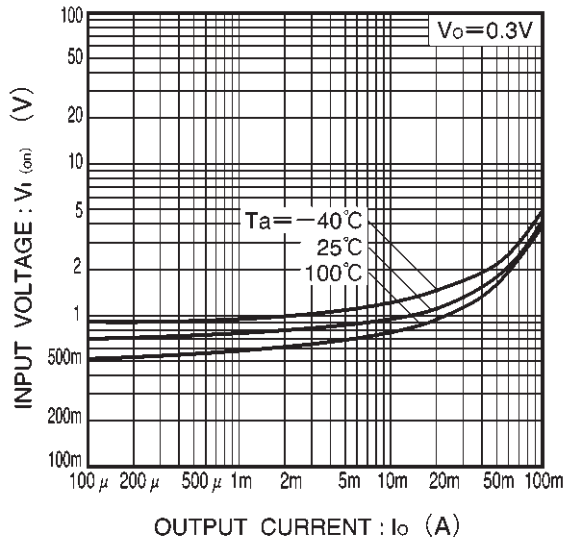
● **Electrical characteristics** (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Input voltage	V <sub>I(off)</sub>	-	-	0.3	V	V <sub>CC</sub> =5V, I <sub>o</sub> =100μA
	V <sub>I(on)</sub>	3	-	-		V <sub>o</sub> =0.3V, I <sub>o</sub> =20mA
Output voltage	V <sub>O(on)</sub>	-	0.1	0.3	V	I <sub>o</sub> /I <sub>i</sub> =10mA/0.5mA
Input current	I <sub>i</sub>	-	-	3.8	mA	V <sub>I</sub> =5V
Output current	I <sub>o(off)</sub>	-	-	0.5	μA	V <sub>CC</sub> =50V, V <sub>I</sub> =0V
DC current gain	G <sub>I</sub>	33	-	-	-	V <sub>o</sub> =5V, I <sub>o</sub> =10mA
Input resistance	R <sub>1</sub>	1.54	2.2	2.86	kΩ	-
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	3.6	4.5	5.5	-	-
Transition frequency	f <sub>T</sub> *	-	250	-	MHz	V <sub>CE</sub> =10V, I <sub>E</sub> =-5mA, f=100MHz

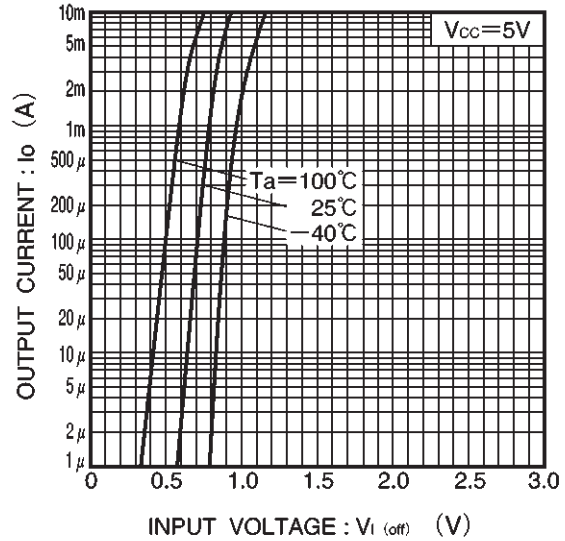
\* Characteristics of built-in transistor

**LDTC123YET1G**

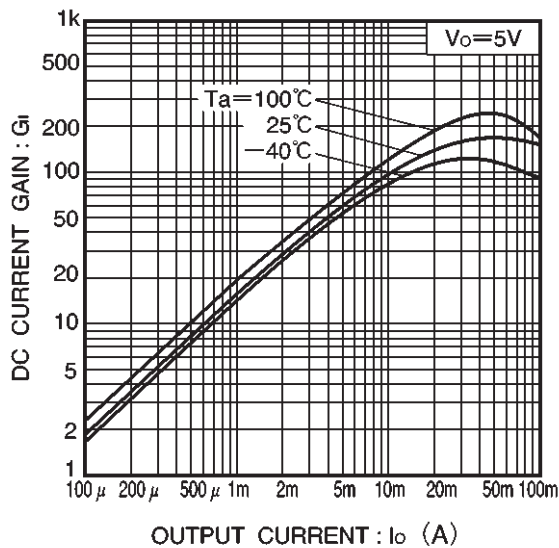
● **Electrical characteristic curves**



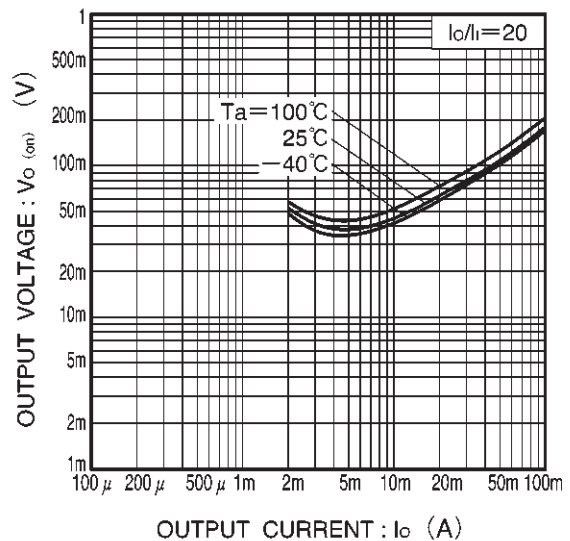
**Fig.1** Input voltage vs. output current (ON characteristics)



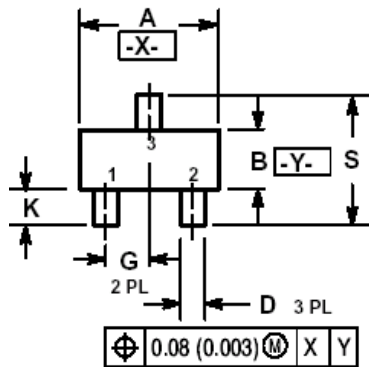
**Fig.2** Output current vs. input voltage (OFF characteristics)



**Fig.3** DC current gain vs. output current

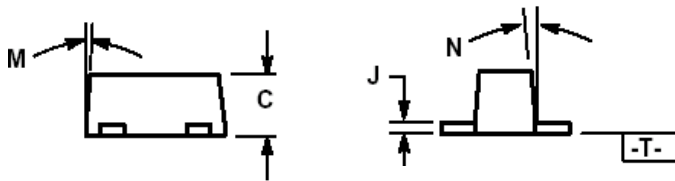


**Fig.4** Output voltage vs. output current

**LDTC123YET1G**
**SC-89**


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 463C-01 OBSOLETE, NEW STANDARD 463C-02.



DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50	1.60	1.70	0.059	0.063	0.067
B	0.75	0.85	0.95	0.030	0.034	0.040
C	0.60	0.70	0.80	0.024	0.028	0.031
D	0.23	0.28	0.33	0.009	0.011	0.013
G	0.50 BSC			0.020 BSC		
H	0.53 REF			0.021 REF		
J	0.10	0.15	0.20	0.004	0.006	0.008
K	0.30	0.40	0.50	0.012	0.016	0.020
L	1.10 REF			0.043 REF		
M	---	---	10 °	---	---	10 °
N	---	---	10 °	---	---	10 °
S	1.50	1.60	1.70	0.059	0.063	0.067

